
Chai Ly Min receives Telekom Excellence Award

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The dream of becoming an outstanding student finally came true when Chai Ly Min, 24, was awarded Telekom Excellence Award at the 14th Convocation Ceremony of Universiti Malaysia Pahang (UMP) on 16 November 2019.

She is grateful for her sacrifice to succeed when receiving a Cumulative Grade Point Average (CGPA) of 3.79 during her four years of study in UMP.

"I am delighted with this success and it is certainly coming from the encouragement of my beloved parents, Chai Kok Yew, 67, and Tan Kam Lin, 57, who have always supported me to study hard.

"I am also happy that I am now working as an engineer at a private company in Kulim, Kedah before graduation.

"All the blood, sweat and tears finally had paid off," she said.

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